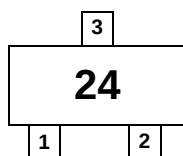
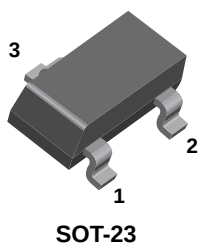


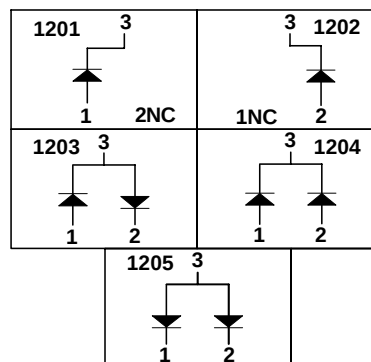
MMBD1201 / 1202 / 1203 / 1204 / 1205

Small Signal Diodes



MMBD1201 24 MMBD1202 25
MMBD1203 26 MMBD1204 27
MMBD1205 28

Connection Diagram



Absolute Maximum Ratings* $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Maximum Repetitive Reverse Voltage	100	V
$I_{F(AV)}$	Average Rectified Forward Current	200	mA
I_{FSM}	Non-repetitive Peak Forward Surge Current		
	Pulse Width = 1.0 second	1.0	A
	Pulse Width = 1.0 microsecond	2.0	A
T_{STG}	Storage Temperature Range	-55 to +150	$^\circ\text{C}$
T_J	Operating Junction Temperature	150	$^\circ\text{C}$

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

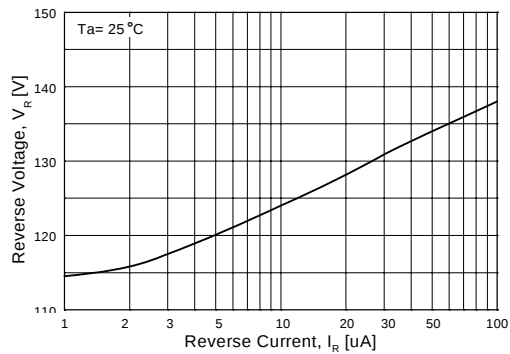
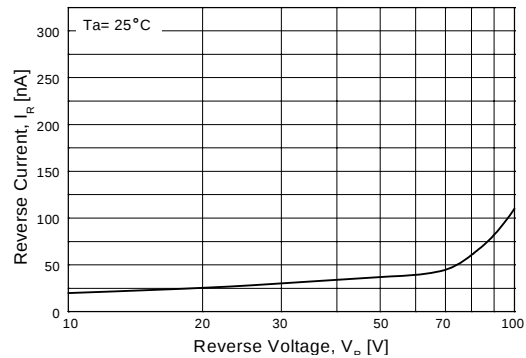
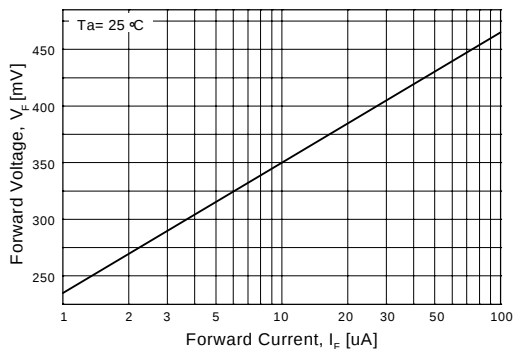
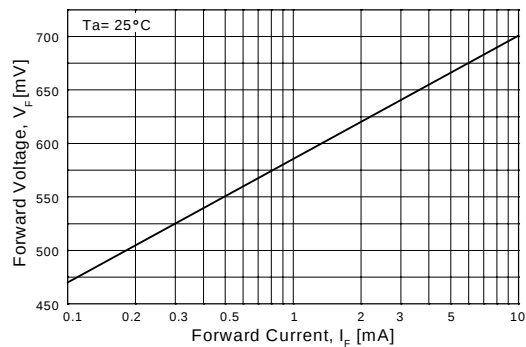
- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
P_D	Power Dissipation	350	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	$^\circ\text{C/W}$

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V_R	Breakdown Voltage	$I_R = 100\mu\text{A}$	100		V
V_F	Forward Voltage	$I_F = 1.0\text{mA}$	550	600	mV
		$I_F = 10\text{mA}$	660	740	mV
		$I_F = 100\text{mA}$	820	920	mV
		$I_F = 200\text{mA}$	0.87	1.0	V
		$I_F = 300\text{mA}$	-	1.1	V
I_R	Reverse Leakage	$V_R = 20\text{V}$		25	nA
		$V_R = 50\text{V}$		50	nA
		$V_R = 50\text{V}, T_A = 150^\circ\text{C}$		5.0	μA
C_T	Total Capacitance	$V_R = 0, f = 1.0\text{MHz}$		2.0	pF
t_{rr}	Reverse Recovery Time	$I_F = I_R = 10\text{mA}, I_{RR} = 1.0\text{mA}$ $R_L = 100\Omega$		4.0	ns

Typical Performance Characteristics**Figure 1. Reverse Voltage vs Reverse Current**
BV - 1.0 to 100uA**Figure 2. Reverse Current vs Reverse Voltage**
IR - 10 to 100 V**Figure 3. Forward Voltage vs Forward Current**
VF - 1.0 to 100 uA**Figure 4. Forward Voltage vs Forward Current**
VF - 0.1 to 10 mA

Typical Performance Characteristics (Continued)

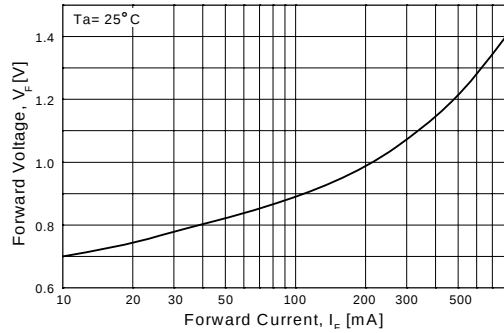


Figure 5. Forward Voltage vs Forward Current
VF - 10 - 800 mA

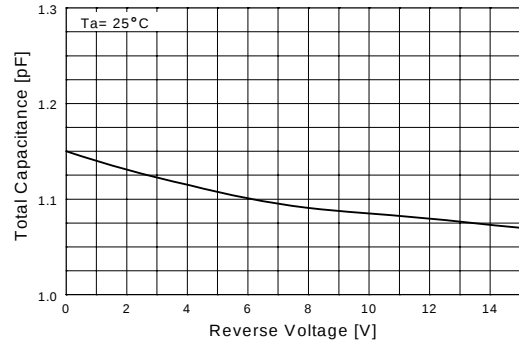


Figure 6. Total Capacitance vs Reverse Voltage

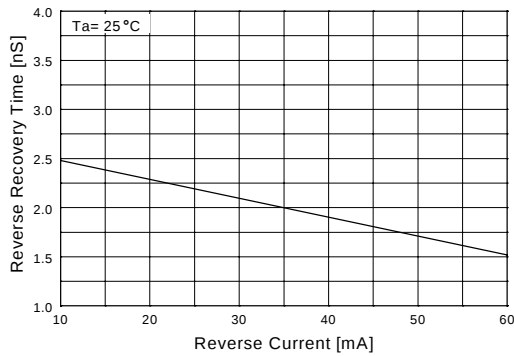


Figure 7. Reverse Recovery Time vs Reverse Current
TRR - IR 10 mA vs 60 mA

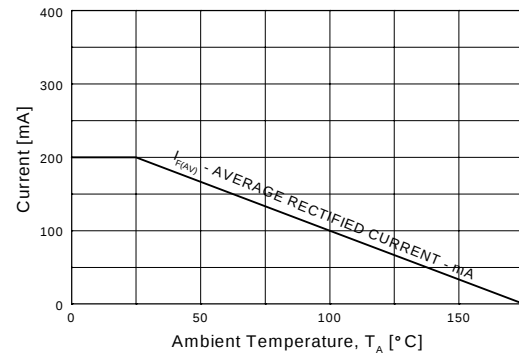


Figure 8. Average Rectified Current ($I_{F(AV)}$) versus Ambient Temperature (T_A)

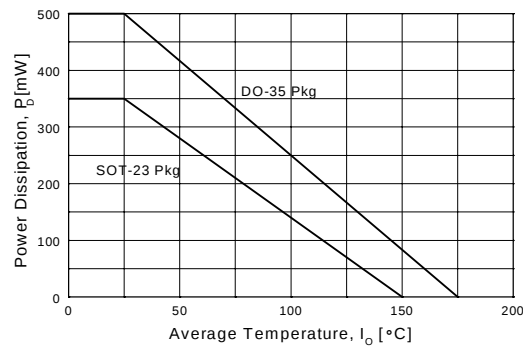
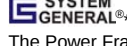


Figure 9. Power Derating Curve



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